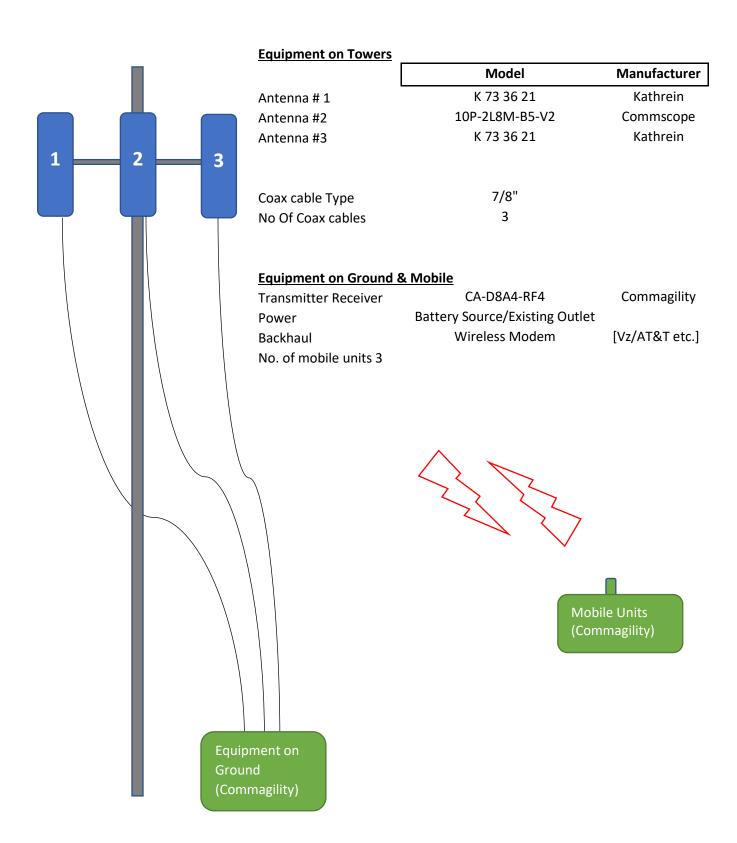
Equipment Specifications



CA-D8A4-RF4

Stand-alone baseband processing and RF card for eNodeB and UE in an LTE-A network



- Includes four high quality, flexible and wideband RF channels, supporting MIMO and carrier aggregation
- Combines 4 ARM® Cortex®-A15 cores with 8 TI C66x+ DSP cores, accelerators and shared memory, plus FPGA, RF and CPRI interfaces
- · Supported by CommAgility small cell and UE, PHY and stack software

The CommAgility CA-D8A4-RF4 is a standalone baseband processing and RF card supporting eNodeB and UE functionality in an LTE-A network.

The card includes four RF channels, tuneable in pairs over a very wide frequency range to cover LTE and unlicensed frequency bands, and with RF bandwidth up to 100MHz to support carrier aggregation and 5G applications.

The RF channels include low latency control features to support UE and eNodeB operation. Discrete ADCs and DACs ensure high RF quality. Optional RF front end cards provide amplification and filtering to support specific bands in over-the-air applications.

generation of DSP/ARM SoCs. This SoC provides Layer 1-3 baseband processing, with a Gigabit Ethernet interface to the network. The EPC functionality can also be integrated into the SoC if required, giving a fully stand-alone network.

A Kintex-7 FPGA provides RF control, digital up/down conversion and processing, interfacing over CPRI to on-board baseband processing or external SFP+ interfaces.

For eNodeB, the card is supported by CommAgility's SmallCellPHY-TI and SmallCellSTACK LTE Release 10 software. For UE, the card is supported by CommAgility's MobilePHY-TI and MobileSTACK LTE Release 10 software. A

Hardware Specifications

DSP0: TMS320TCI6638K2K KeyStone II

- 8x C66x DSP cores @ 1.2GHz
- 4x ARM A15 cores @ 1.4GHz
- · Accelerators and packet processors
- 2Gbytes x72 DDR3L-1600 SDRAM
- 512Mbytes x16 boot FLASH
- 3x 5Gbaud AIF2 CPRI lanes
- · GbE and UART interfaces
- 20Gbaud RapidIO interface

FPGAO: Xilinx Kintex-7TM K410T FPGA

- · Optional 3 CPRI lanes at up to 10.3Gbaud (CPRI rate 8)
- Interfaces to RF and DSP0
- . Configured by DSP0 at boot-up
- · Supplied with CommAgility image which performs RF control, up conversion and down conversion, CPRI interfacing etc.
- Crest Factor Reduction support optional

Timing:

- . Integrated GPS for timing sync
- Clock and sync
- Configurable PLL/jitter cleaner
- . Timing from GPS, IEEE1588, received RF or external clock source

External I/O:

- · Four flexible RF channels, each with separate Tx/Rx SMA ports
- . 3x SFP+ to DSP AIF2 or FPGA, up to 10.3Gbaud
- . GPS aerial and 2 x SMB clock/sync
- RJ45 and SFP+ Gigabit Ethernet
- 12V power connector
- SFF-8643 to DSP RapidIO

Form Factor:

- · Standalone card with optional RF frontend cards for amplification and filtering
- Dimension: 225mm (L) x 165mm (W) x 26.5mm (H)

Debug:

- DSP and FPGA debug connectors
- · Mini-USB B jack and LEDs

Environment/EMC/Safety

- Operating temp: -40°C to +70°C ambient (conduction cooled)
- Power consumption: typically <60W
 2011/65/EU RoHS and EC/1907/2006 REACH compliant

RF Specifications

RF Channels:

- · Four channels
- · Each pair in a set is identical and frequency synchronized
- . Two sets can be synchronized or set to different frequencies
- . Tx and Rx can be the same (TDD) or different (FDD) frequencies

Frequency and Bandwidth:

- RF Freq Range: 410MHz 5925MHz
- · RF Fine Freq Resolution: <1Hz
- RF Bandwidths supported: 1.4, 3, 5, 10, 15, 20, 30, 40, 100MHz
- · Actual baseband sampling rates: up to 245.76MSPS
- . For other RF configurations (for example narrowband LTE), please contact CommAgility

TX Ports:

- Maximum Rated Output Power (PRAT) +21dBm eNodeB, +23dBm UE per antenna
- . 0dBm without front-end module
- Tx Dynamic Range: >50dB
- . EVM: <2% at 0dBm without FEM
- DAC SFDR: >55dB

RX Ports:

- · Maximum operational input power 0dBm
- Noise figure: <5dB, Pin <-50dBm with optional FEM
- . Gain range: 50dBm supporting AGC with optional FEM

Calibration and Tuning:

· Continuous auto-tuning of RF receive parameters

USIM Support:

 Standard uSIM connection allows UE applications to be supported with suitable external RF

Panel Vertical Polarization Half-power Beam Width

408-512	l
V	ı
63*	i



VPol Panel 408-512 63* 9dBl

Type No.	K 73 36 21				
Frequency range					
Polarization	Versical				
Gain	9 dB H-plane: 63* E-plane: 63*				
Half-power beam width					
Impedance	50 D				
VSWR	< 1.4				
Max. power	500 W (at 50 °C ambient temperature)				

Arrays: This arranna is especially suitable as a con-

ponent in arrays to achieve various raciation

PARSITY.

Scope of supply: Anstrona including two weather-proof covers

for intelight and elbow connector, but without

mounting hardware.

Material: Dipoles and reflector screen: Weather-resistant

aluminum.

Radome: Fiberglate, colour: White. All screws and nuts: Stainless steel.

Attachment: Use damps K 61 14 0 .. for subular mail: dla-

meters of 40 - 521 mm (see the "Mechanical

Accessories" part of this catalogue).

Ice protection: Due to the very sturely antenna construction and

the protection of the radiating system by the radiome, the artenna remains operational even

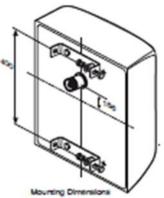
under ley conditions.

Grounding: All metal parts of the america including the

mounting kit are DC grounded.

The inner conductor is capacitively coupled.









Input	N fernale					
Connector position	Rearride					
Weight	6 kg					
Wind load	Fromal: Lateral: Rearride:	220 N (at 150 km/h) 100 N (at 150 km/h) 330 N (at 150 km/h)				
Max. wind velocity	200 km/h					
Packing size	603 x 567 x 262 mm					
HeighsWidth/depth	493 / 493 / 209 mm					

10P-2L8M-B5-V2



10-port sector antenna, 2x 694–960 and 8x 1695–2690 MHz, 65° HPBW, 5x RET

- All Internal RET actuators are connected in "Cascaded SRET" configuration
- Utilizes RET-PMOD-A20-5A07

General Specifications

Antenna Type Sector

Band Multiband

Grounding Type RF connector inner conductor and body grounded to reflector and

mounting bracket

Performance Note Outdoor usage

Radome Material Fiberglass, UV resistant

Radiator Material Low loss circuit board

Reflector Material Aluminum

RF Connector Interface 7-16 DIN Female

RF Connector Location Bottom
RF Connector Quantity, high band 8
RF Connector Quantity, low band 2
RF Connector Quantity, total 10

Remote Electrical Tilt (RET) Information

RET Hardware CommRET v2

RET Interface 2x 8 pin connector as per IEO 60130-9 Daisy chain in: Male / Daisy chain

out: Female Pin3: RS485A(AISG_B), Pin5: RS485B(AISG_A), Pin6: DC

10~30V, Pin7: DC_ Return

RET Interface, quantity 1 female | 1 male

10P-2L8M-B5-V2

Input Voltage 10-30 Vdc

Internal RET High band (4) | Low band (1)

Power Consumption, idle state, maximum 2 W
Power Consumption, normal conditions, maximum 10 W

Protocol 3GPP/AISG 2.0 (Single RET)

Dimensions

 Width
 301 mm | 11.85 in

 Depth
 181 mm | 7.126 in

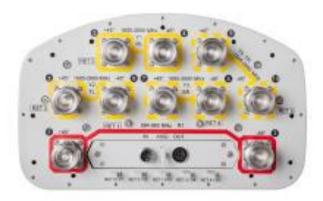
 Length
 2090 mm | 82.284 in

 Net Weight, without mounting kit
 21.9 kg | 48.281 lb

Array Layout

_		Array	Freq (MHz)	Conns	RET (SRET)	AISG RET UID
		R1	694-960	1-2	1	CPxxxxxxxxxxxxxxxxxxxXR1
Y2	Y4	Y1	1695-2690	3-4	2	CPxxxxxxxxxxxxxxxxxxXY1
	_	Y2	1695-2690	5-6	3	CPxxxxxxxxxxxxxxxxxx
		Y3	1695-2690	7-8	4	CPxxxxxxxxxxxxxxxXY3
Y1	Y3	Y4	1695-2690	9-10	5	CPxxxxxxxxxxxxxxxxx44
R1						
Left	Right	(Sizes of	colored baxes are n	ot		

10P-2L8M-B5-V2



Electrical Specifications

mpedance 50 ohn

Operating Frequency Band 1695 - 2690 MHz | 694 - 960 MHz

Polarization ±45°
Total Input Power, maximum 900 W

Electrical Specifications

Frequency Band, MHz	694-790	790-890	890-960	1695-1920	1920-2200	2300-2500	2500-2690
Gain, dBi	15.5	15.8	16.1	16.6	16.9	16.9	17.1
Beamwidth, Horizontal, degrees	73	70	68	63	62	60	63
Beamwidth, Vertical, degrees	10.7	9.6	8.9	8.7	7.9	6.9	6.5
Beam Tilt, degrees	0-12	0-12	0-12	0-12	0-12	0-12	0-12
USLS (First Lobe), dB	17	17	20	17	18	20	20
Front-to-Back Ratio at 180°, dB	32	32	30	34	34	32	36
Front-to-Back Ratio, Copolarization 180° ± 30°, dB	27	27	27	29	29	30	30
Isolation, Cross Polarization, dB	25	25	25	25	25	25	25